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October 2013

# RURD660S9A\_F085 Ultrafast Power Rectifier, 6A 600V

#### **Features**

- High Speed Switching (t<sub>rr</sub>=63ns(Typ.) @ I<sub>F</sub>=6A)
- Low Forward Voltage(V<sub>F</sub>=1.26V(Typ.) @ I<sub>F</sub>=6A)
- · Avalanche Energy Rated
- · AEC-Q101 Qualified

## **Applications**

- General Purpose
- · Switching Mode Power Supply
- · Power switching circuits

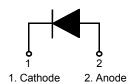
#### 6A, 600V Ultrafast Rectifier

The RURD660S9A\_F085 is an ultrafast diode with soft recovery characteristics (trr< 83ns). It has a low forward voltage drop and is of silicon nitride passivated ionimplanted epitaxial planar construction. This device is intended for use as a freewheeling/clamping diode and rectifier in a variety of switching power supplies and other power switching applications. Its low stored charge and ultrafast soft recovery minimize ringing and electrical noise in many power switching circuits, thus reducing powerloss in the switching transistors.

## **Pin Assignments**



1. Cathode 2. Anode



## Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units	
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	600	V	
V <sub>RWM</sub>	Working Peak Reverse Voltage	600	V	
V <sub>R</sub>	DC Blocking Voltage	600	V	
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>C</sub> = 25°C	6	Α	
I <sub>FSM</sub>	Non-repetitive Peak Surge Current	60	Α	
T <sub>J,</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature	- 55 to +175	°C	

#### Thermal Characteristics T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Max	Units
$R_{ heta JC}$	Maximum Thermal Resistance, Junction to Case 3		°C/W
R <sub>θJA</sub> <sup>1</sup>	Maximum Thermal Resistance, Junction to Ambient	140	°C/W
R <sub>0JA</sub> <sup>2</sup>	Maximum Thermal Resistance, Junction to Ambient	50	°C/W

## **Package Marking and Ordering Information**

<b>Device Marking</b>	Device	Package	Tube	Quantity	
RUR660 RURD660S9A_F085		TO-252-2L	-	60	

#### Notes:

- 1. Mounted on a minimum pad follow by JEDEC standard.
- 2. Mounted on a 1 in 2 pad of 2 oz copper follow by JEDEC standard.

## **Electrical Characteristics** $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Conditions		Min.	Тур.	Max	Units
I <sub>R</sub>	Instantaneous Reverse Current	V <sub>R</sub> = 600V	T <sub>C</sub> = 25 °C	-	-	100	uA
			T <sub>C</sub> = 175 °C	-	-	500	uA
V <sub>FM</sub> <sup>3</sup>	Instantaneous Forward Voltage	I <sub>F</sub> = 6A	T <sub>C</sub> = 25 °C T <sub>C</sub> = 175 °C	-	1.26 1.04	1.5 -	V V
t <sub>rr</sub> <sup>4</sup>	Reverse Recovery Time	I <sub>F</sub> =1A, di/dt = 200A/μs, V <sub>CC</sub> = 390V	T <sub>C</sub> = 25 °C	-	25	33	ns
		$I_F$ =6A, di/dt = 200A/ $\mu$ s, $V_{CC}$ = 390V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 175 °C	-	63 119	83	ns ns
t <sub>a</sub> t <sub>b</sub> Q <sub>rr</sub>	Reverse Recovery Time Reverse Recovery Charge	$I_F$ =6A, di/dt = 200A/µs, V <sub>CC</sub> = 390V	T <sub>C</sub> = 25 °C	- - -	23 40 151	- - -	ns ns nC
W <sub>AVL</sub>		Avalanche Energy (L = 20mH)		10	-	-	mJ

#### Notes:

- 3. Pulse : Test Pulse width =  $300\mu s$ , Duty Cycle = 2%
- 4. Guaranteed by design

### **Test Circuit and Waveforms**

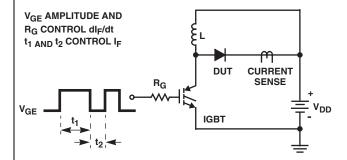


FIGURE 8. trTEST CIRCUIT

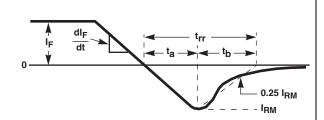


FIGURE 9. ‡ WAVEFORMS AND DEFINITIONS

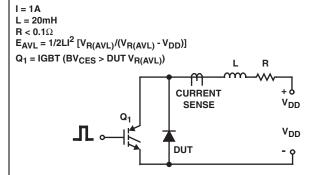


FIGURE 10. AVALANCHE ENERGY TEST CIRCUIT

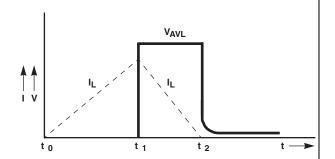
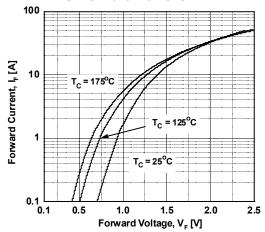


FIGURE 11. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

## **Typical Performance Characteristics**

Figure 1. Typical Forward Voltage Drop vs. Forward Current



**Figure 3.Typical Junction Capacitance** 

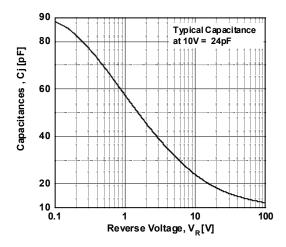


Figure 5. Typical Reverse Recovery Current vs. di/dt

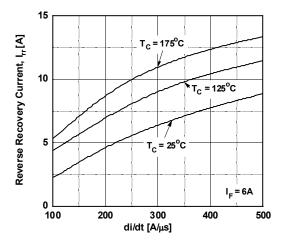


Figure 2. Typical Reverse Current vs.

Reverse Voltage

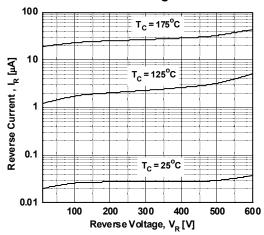


Figure 4. Typical Reverse Recovery Time vs. di/dt

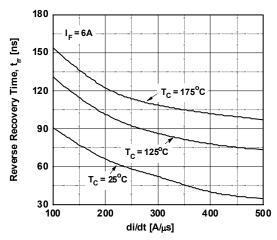
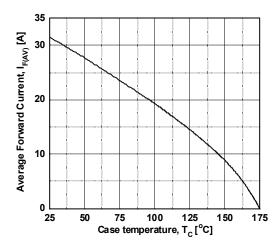


Figure 6. Forward Current Derating Curve



## **Typical Performance Characteristics** (Continued)

Figure 7. Reverse Recovery Charge

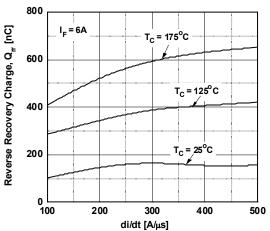
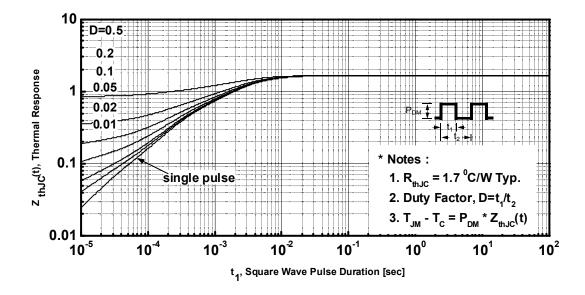
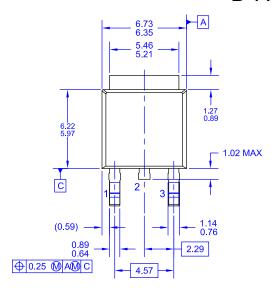


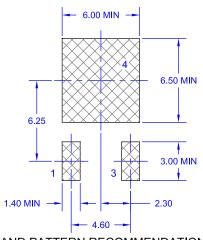
Figure 8. Transient Thermal Response Curve

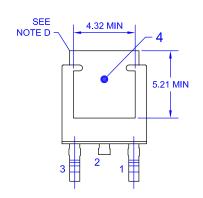


#### **Mechanical Dimensions**

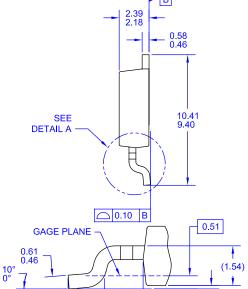
## **D-PAK**











1.78 1.40

(2.90)

- NOTES: UNLESS OTHERWISE SPECIFIED
  A) THIS PACKAGE CONFORMS TO JEDEC, TO-252, ISSUE C, VARIATION AA.
  B) ALL DIMENSIONS ARE IN MILLIMETERS.
  C) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
  D) HEAT SINK TOP EDGE COULD BE IN CHAMFERED CORNERS OR EDGE PROTRUSION.
  E) PRESENCE OF TRIMMED CENTER LEAD IS OPTIONAL
- E) PRESENCE OF TRIMMED CENTER LEAD IS OPTIONAL.

  F) DIMENSIONS ARE EXCLUSSIVE OF BURSS, MOLD FLASH AND TIE BAR EXTRUSIONS.

  G) LAND PATTERN RECOMENDATION IS BASED ON IPC7351A STD TO220P1003X238-3N.

  H) DRAWING NUMBER AND REVISION: MKT-TO252A03REV8

**Dimensions in Millimeters** 

SEATING PLANE

0.127 MAX





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